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**SOT-553 Four Lines TVS Array for ESD Protection**

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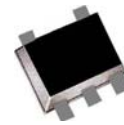
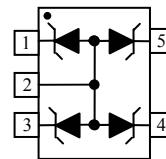
**Description**

TVS diodes are designed to replace multilayer varistors (MLVs) in portable applications such as cell phones, notebook computers, and PDA's. They offer superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs.

The UMD5V-553 is a TVS array designed to protect I/O or data lines from the damaging effects of ESD. Their integrated design provides very effective and reliable protection for four separate lines using only one package. The SOT-553 is a very small package which allows space saving on high density printed circuit board and also gives the designer the flexibility to provide Uni-Directional or Bi-Directional protection.

**Features**

- \* Solid-state silicon avalanche technology
- \* SOT-553 package
- \* Uni-Directional or Bi-Directional protection
- \* Protects up to four data lines
- \* 100 Watts peak pulse power ( $t_p = 8/20\mu s$ )
- \* Working voltage: 5V
- \* Low clamping factor  $V_{cl}/V_{br}$
- \* Low leakage current
- \* Full RoHS compliance
- \* Complies with the following standards:
  - IEC 61000-4-2 (ESD) Air-15kv, Contact-8kv
  - IEC 61000-4-4 (EFT) (5/50ns)
  - IEC 61000-4-5 (Surge) (8/20 $\mu s$ )

**Small Surface Mount Device TVS****SOT-553 Pin Configuration**

<u>Pin</u>	<u>Description</u>
1	Cathode
2	Anode
3	Cathode
4	Cathode
5	Cathode

**Mechanical Characteristics**

- \* Molded SOT-553 package
- \* Weight 3 milligrams (Approximate)
- \* Available in Lead-Free Pure-Tin Plating
- \* Solder Reflow Temp: Pure-Tin (Sn), 260-270°C
- \* Consult Factory for Leaded Device Availability
- \* Flammability Rating UL 94V-0
- \* 8mm Tape and Reel per EIA Standard 481
- \* Device Marking: Marking Code,  
Pin one defined by DOT

**Applications**

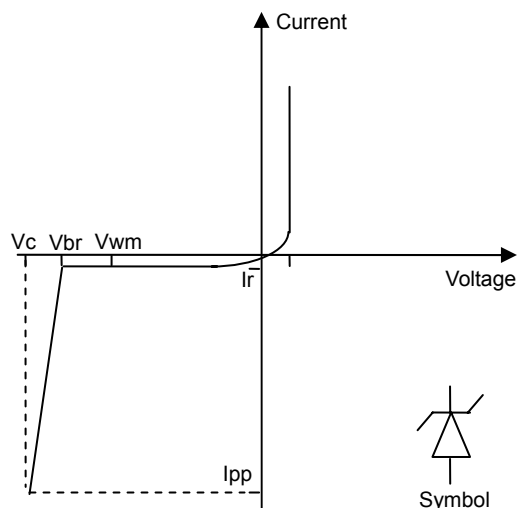
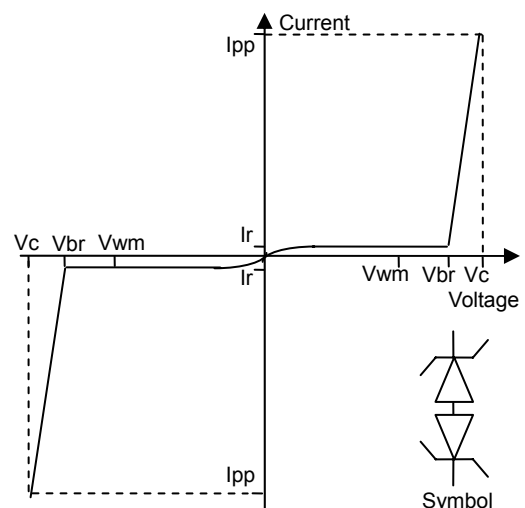
- \* Cellular Handset
- \* PDA
- \* Notebook
- \* Digital Camera
- \* Wifi Phone
- \* Microprocessor Based Equipment

**SOT-553 Four Lines TVS Array for ESD Protection**
**Absolute Maximum Ratings @ 25°C unless otherwise specified**

Parameter	Symbol	Value	Units
Peak Pulse Power; pulse waveform = 8/20μs	P <sub>pp</sub>	100	W
Peak Pulse Current; pulse waveform = 8/20μs	I <sub>pp</sub>	10	A
ESD per IEC 61000-4-2 (Air)	V <sub>pp</sub>	±15	kV
ESD per IEC 61000-4-2 (Contact)		±8	
Operating Temperature	T <sub>j</sub>	-55 to 150	°C
Storage Temperature	T <sub>stg</sub>	-55 to 150	°C

**Electrical Characteristics @ 25°C unless otherwise specified**

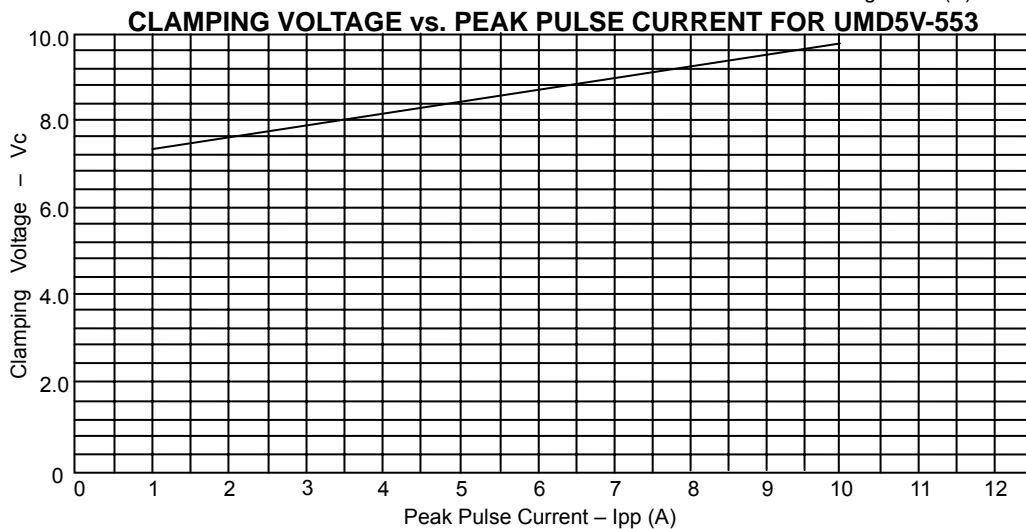
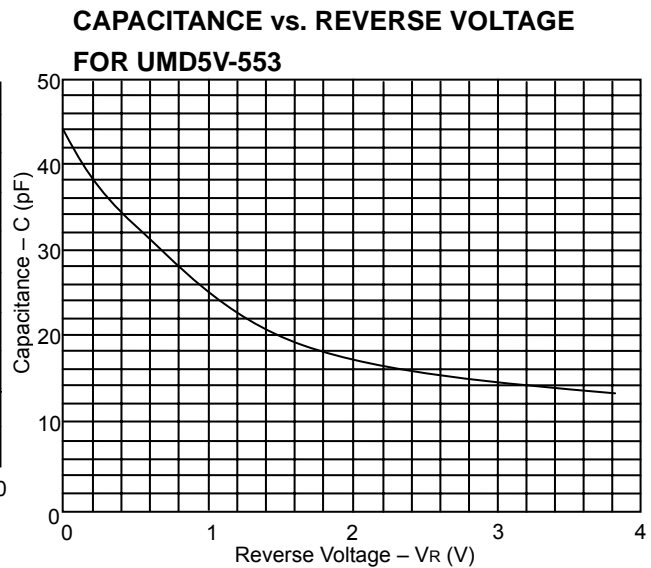
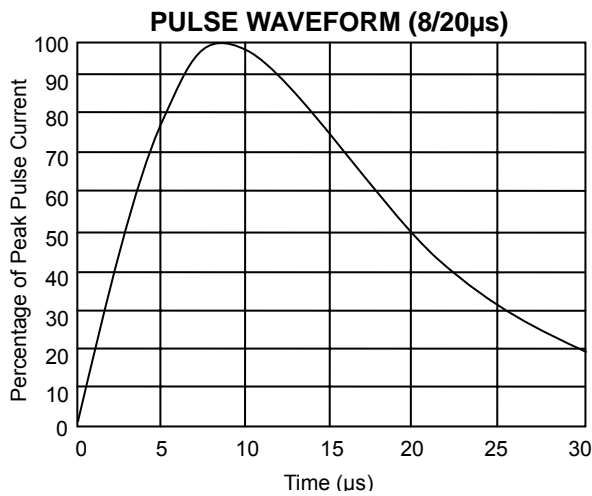
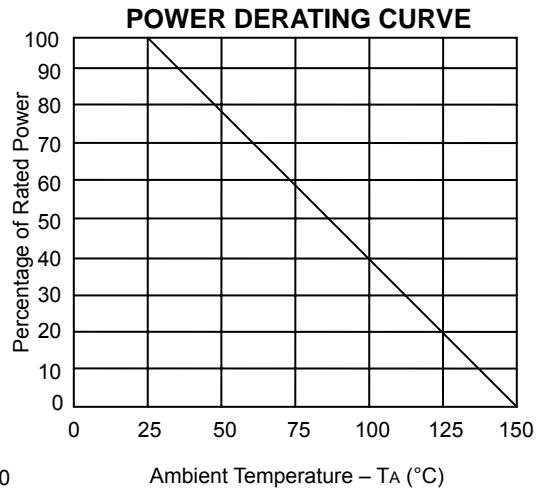
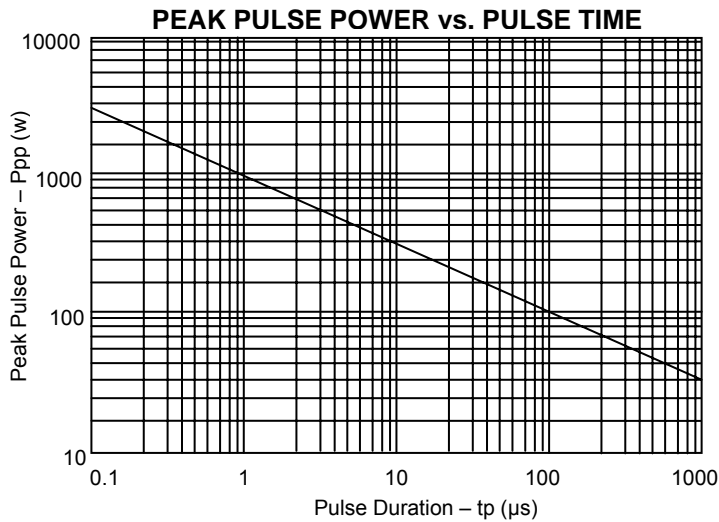
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Stand-off Voltage	V <sub>wm</sub>				5.0	V
Breakdown Voltage	V <sub>br</sub>	I <sub>t</sub> =1mA	6.0			V
Leakage Current	I <sub>r</sub>	V <sub>wm</sub> =5V, T=25°C			5	μA
Clamping Voltage	V <sub>c</sub>	I <sub>pp</sub> =1A T <sub>p</sub> =8/20μs			8.8	V
Clamping Voltage	V <sub>c</sub>	I <sub>pp</sub> =10A T <sub>p</sub> =8/20μs			10.0	V
Peak Pulse Current	I <sub>pp</sub>	T <sub>p</sub> =8/20μs			10	A
Junction Capacitance	C <sub>j</sub>	V <sub>r</sub> =0V, f=1MHz		40		pF

**Uni-Directional Protection**

**Bi-Directional Protection**




SOT-553 Four Lines TVS Array for ESD Protection

Electrical Characteristics Graphs



**SOT-553 Four Lines TVS Array for ESD Protection**

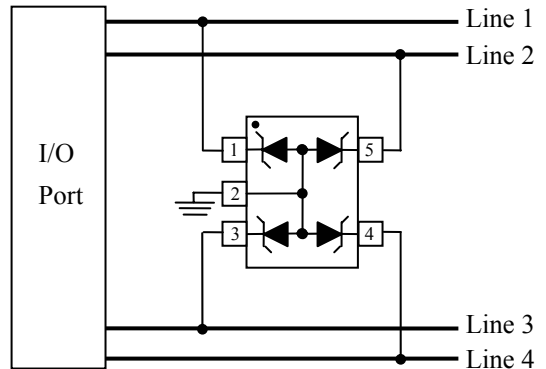
**Applications Information**

The UMD5V-553 is designed for use in applications where board space is at a premium. Each device requires less than 3mm<sup>2</sup> of PCB area and will protect up to four Uni-Directional lines.

The UMD5V-553 provides up to 4 lines of protection in a common-mode Uni-Directional configuration.

Circuit connectivity is as follows:

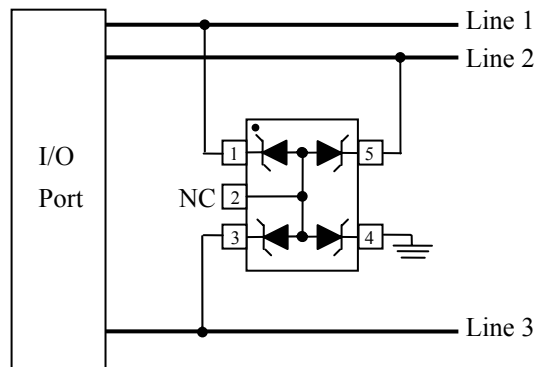
- Line 1 is connected to Pin 1
- Line 2 is connected to Pin 5
- Line 3 is connected to Pin 3
- Line 4 is connected to Pin 4
- Pin 2 is connected to ground



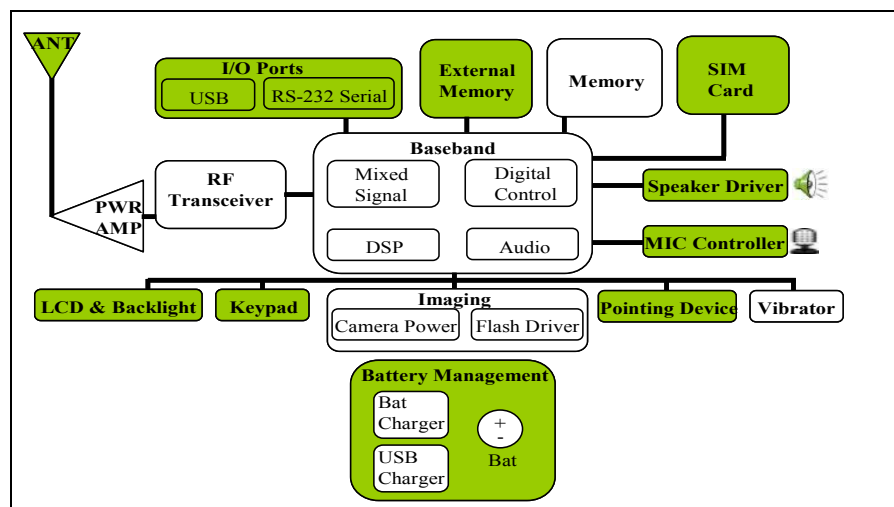
The UMD5V-553 provides up to 3 lines of protection in a common-mode Bi-Directional configuration.

Circuit connectivity is as follows:

- Line 1 is connected to Pin 1
- Line 2 is connected to Pin 5
- Line 3 is connected to Pin 3
- Pin 4 is connected to ground
- Pin 2 is not connected



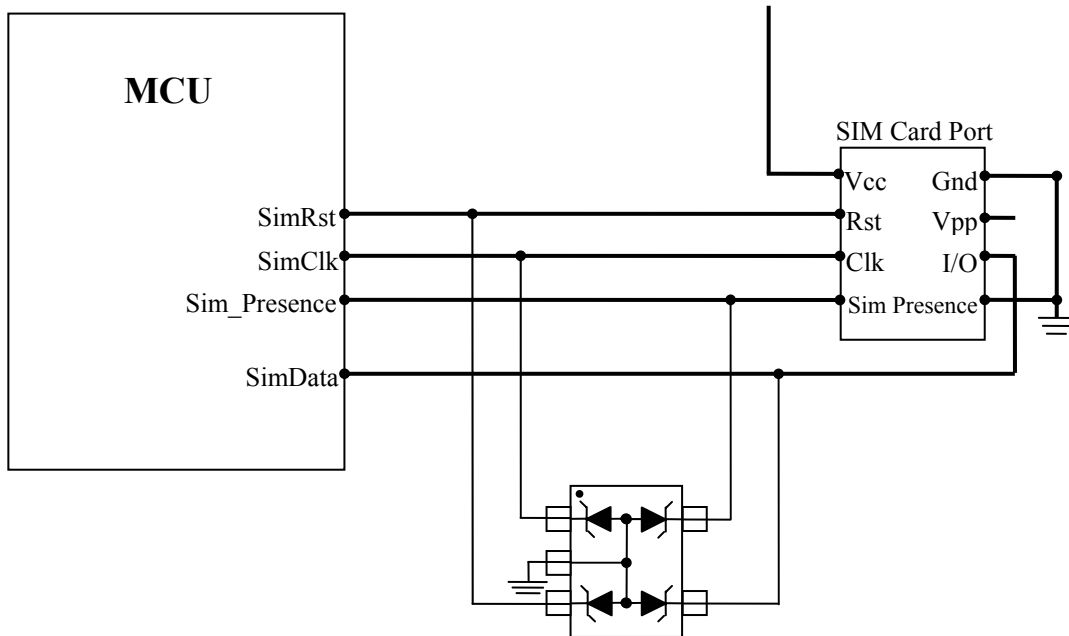
**Mobile Handset Block Diagram**



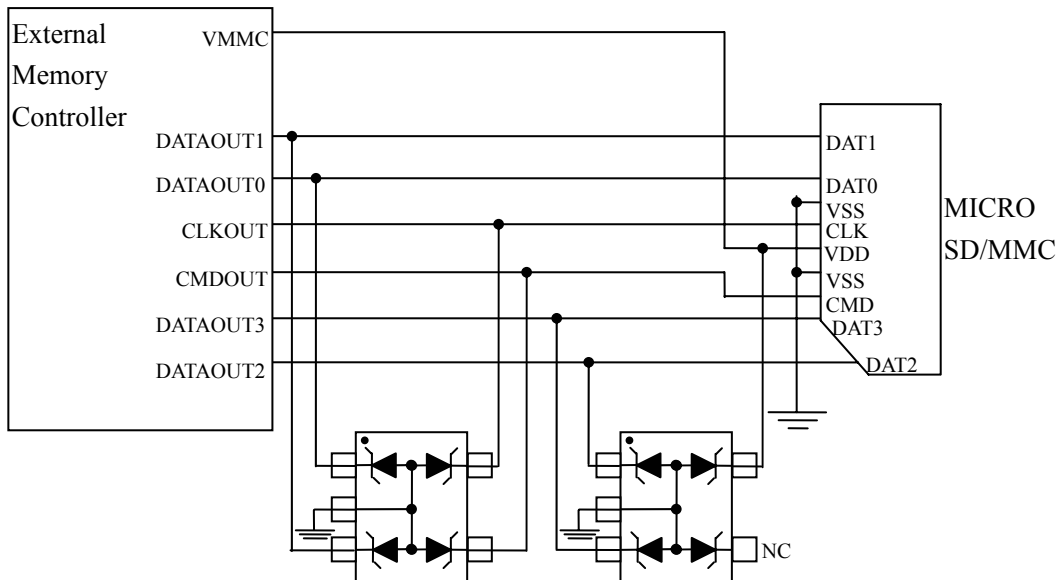
Areas that require ESD protection are highlighted.

SOT-553 Four Lines TVS Array for ESD Protection

UMD5V-553 on Sim Card Port Application

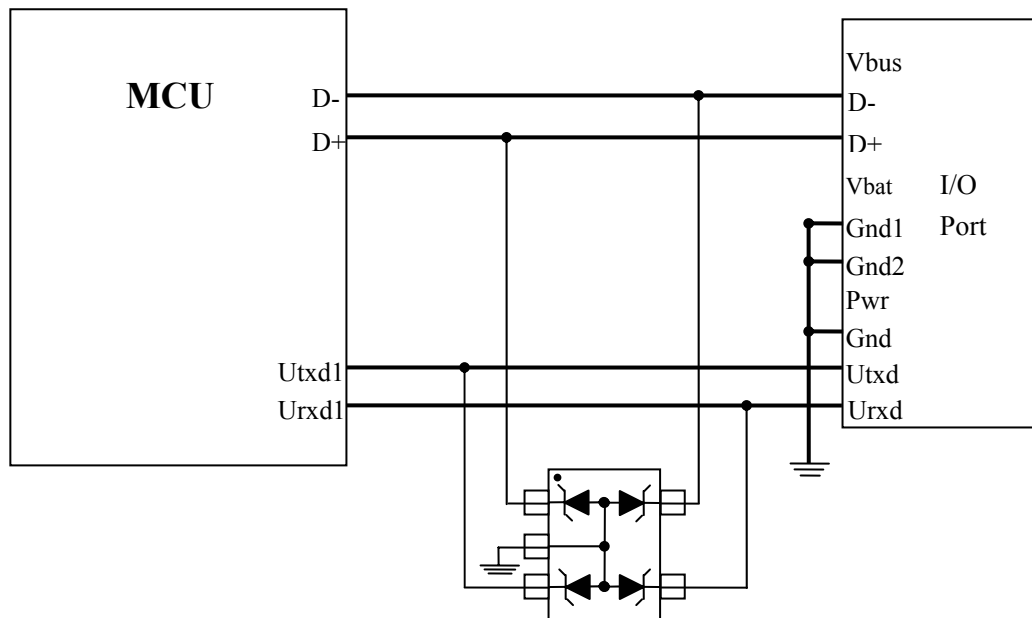


UMD5V-553 on External Micro SD/MMC Port Application

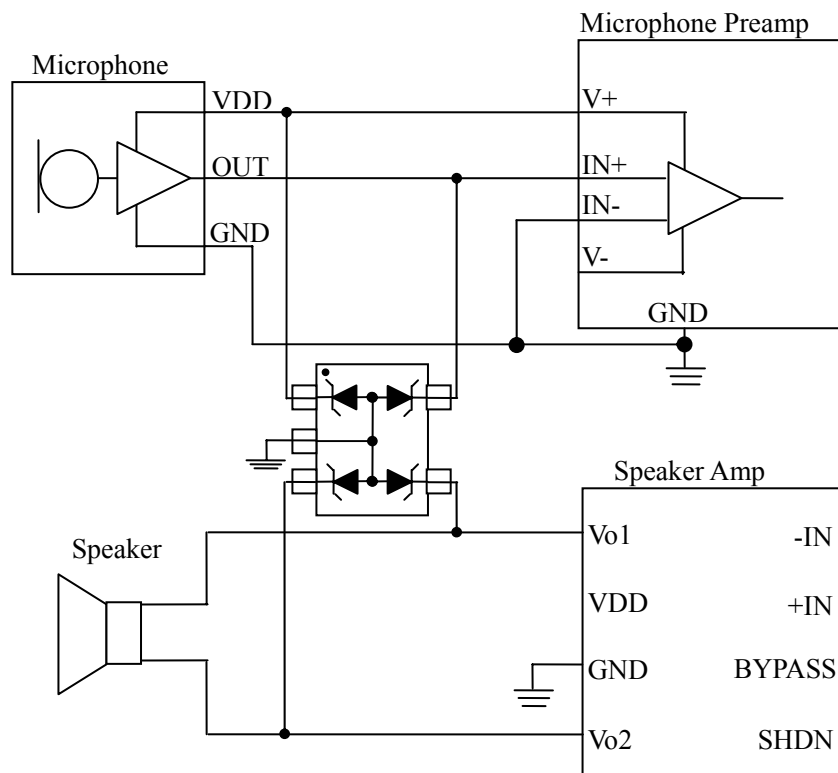


SOT-553 Four Lines TVS Array for ESD Protection

UMD5V-553 on I/O Port Application

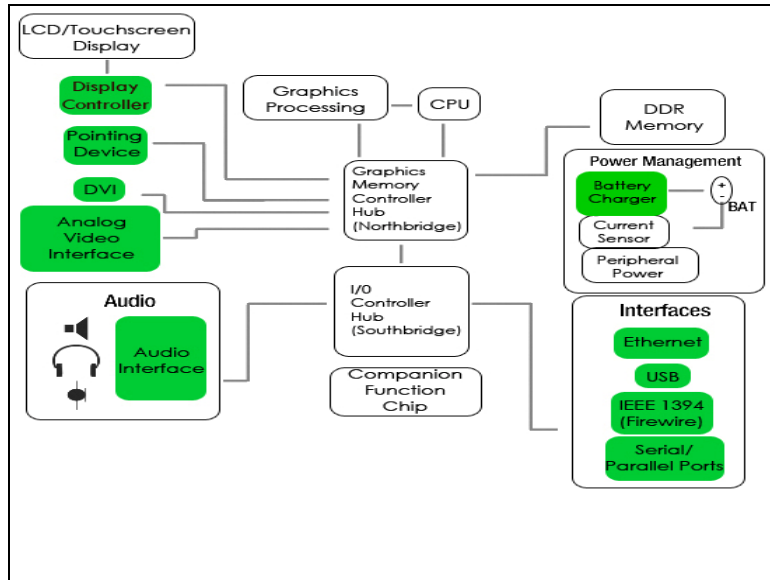


UMD5V-553 on Speaker and Microphone Application



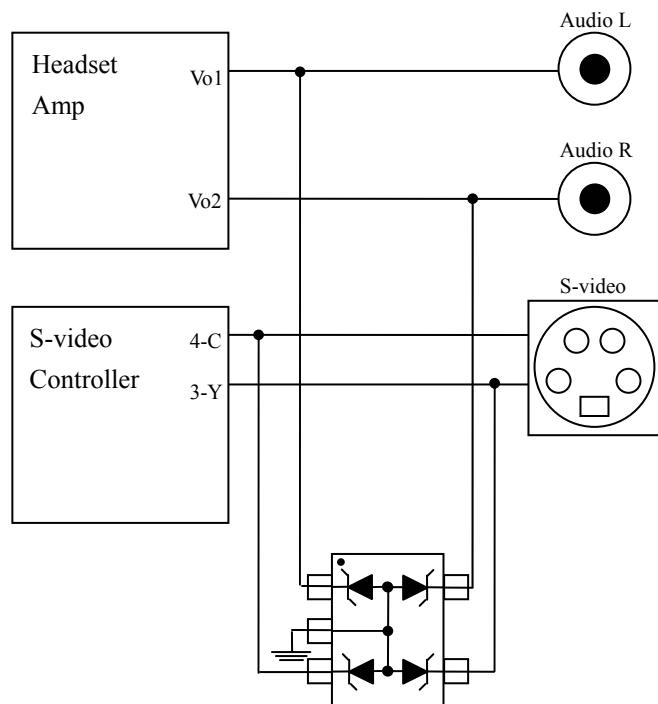
SOT-553 Four Lines TVS Array for ESD Protection

Laptop Block Diagram



Areas that require ESD protection are highlighted.

UMD5V-553 on S-video and Audio Ports Application



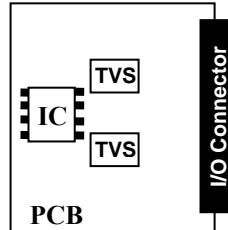
SOT-553 Four Lines TVS Array for ESD Protection

**Circuit Board Layout Recommendations**

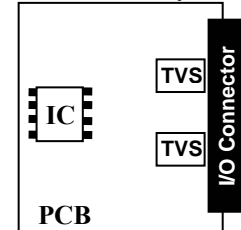
Good circuit board layout is critical for creating an effective surge suppression circuit. The following PCB guidelines are recommended to enhance the performance of a TVS device:

- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- The ESD transient return path to ground should be kept as short as possible.
- Place a TVS and decoupling capacitor between power and ground of components that may be vulnerable to electrostatic discharges to the ground plane.
- Minimize all conductive loops including power and ground loops.
- Use multilayer boards when possible.
- Minimize interconnecting line lengths.
- Never run critical signals near board edges.
- Fill unused portions of the PCB with ground plane.

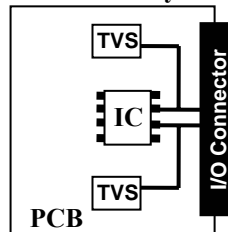
Poor PCB Layout



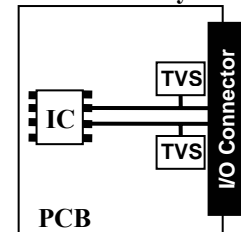
Good PCB Layout



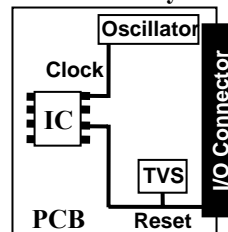
Poor PCB Layout



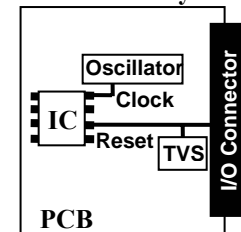
Good PCB Layout



Poor PCB Layout



Good PCB Layout

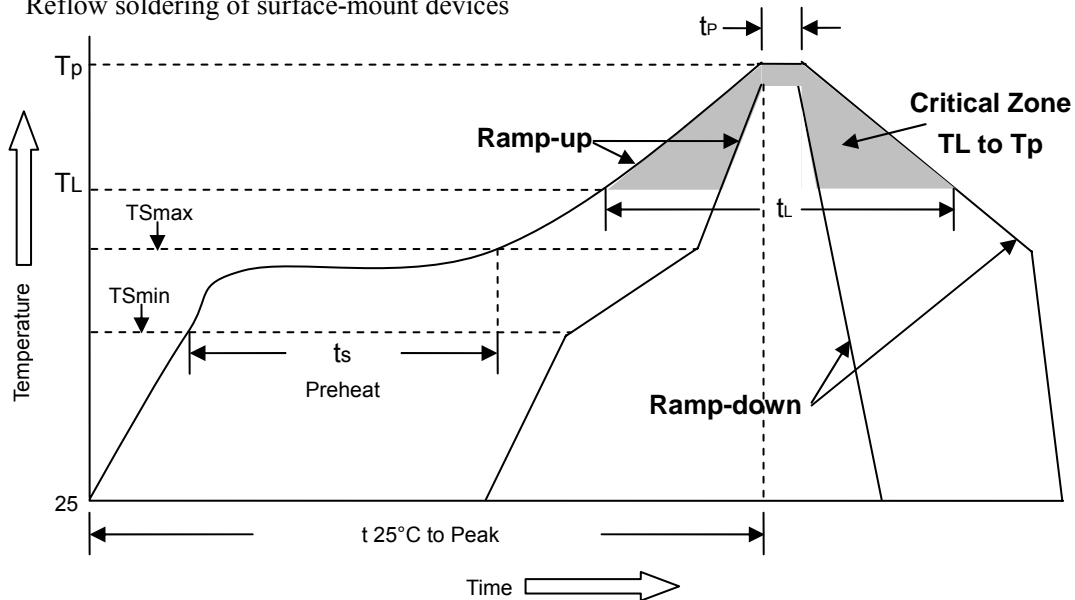


**Matte Tin Lead Finish**

Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. Unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation to solder joint.

**SOT-553 Four Lines TVS Array for ESD Protection**
**Soldering Method for UMD's Products**

1. Storage environment: Temperature = 10°C~35°C Humidity = 65%±15%
2. Reflow soldering of surface-mount devices



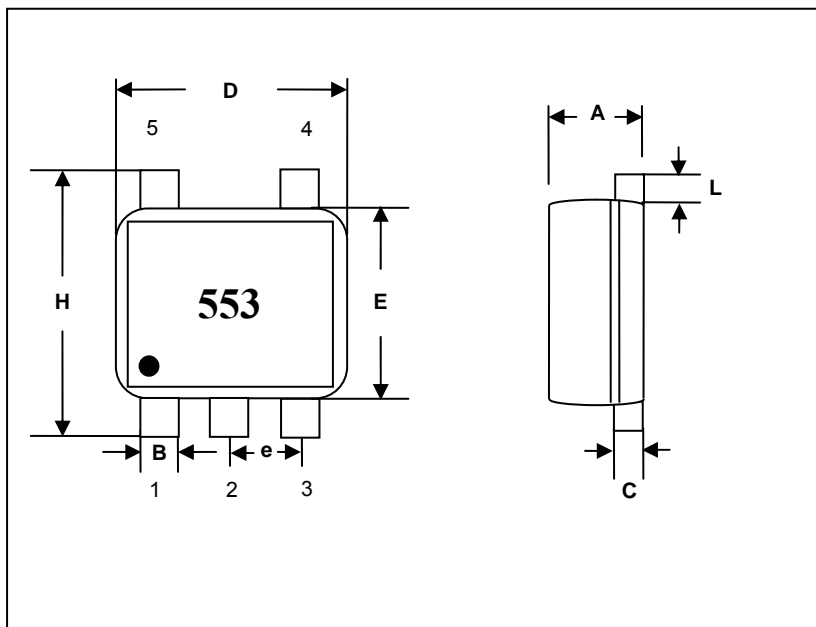
Profile Feature	Pb-Free Assembly
Average ramp-up rate (TL to TP)	<3°C/sec
Preheat	
- Temperature Min (T <sub>Smin</sub> )	150°C
- Temperature Max (T <sub>Smax</sub> )	200°C
- Time (min to max) (t <sub>s</sub> )	60~180sec
T <sub>Smax</sub> to TL	
- Ramp-up Rate	<3°C/sec
Time maintained above:	
- Temperature (TL)	220°C
- Time (t <sub>L</sub> )	50~145sec
Peak Temperature (T <sub>P</sub> )	260°C +0/-5°C
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )	20~40sec
Ramp-down Rate	<6°C/sec
Time 25°C to peak Temperature	<8 minutes

**Flow (wave) soldering (solder dipping)**

Products	Dipping time
Pb devices	5sec±1sec
Pb-Free devices	5sec±1sec

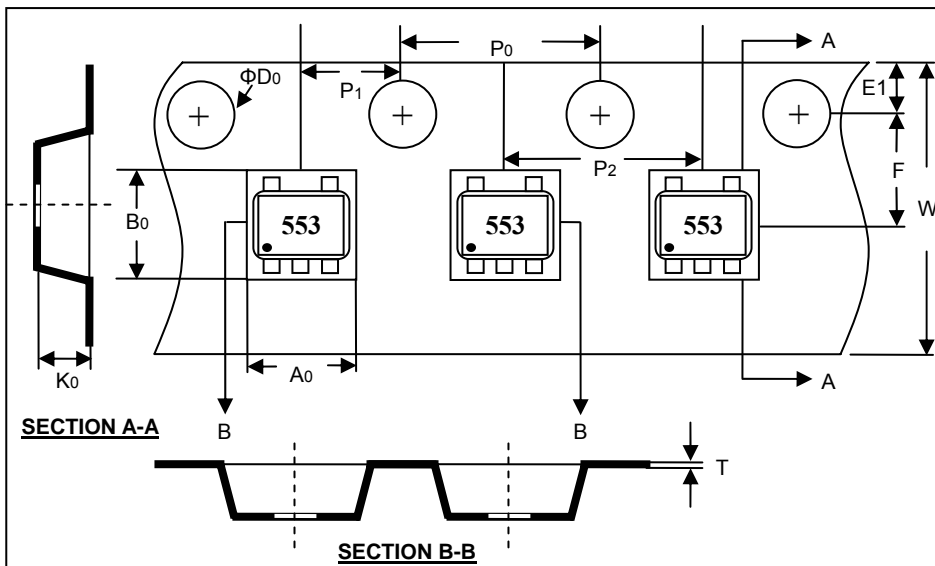
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UMD5V-553 Dimension Drawing

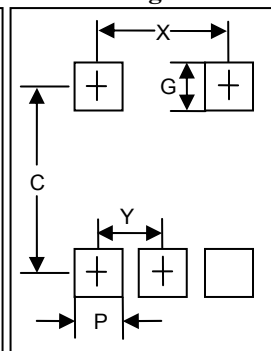


Dim	Dimensions			
	Inches		mm	
	Min	Max	Min	Max
A	0.020	0.024	0.50	0.60
H	0.059	0.067	1.50	1.70
B	0.007	0.011	0.17	0.27
D	0.059	0.067	1.50	1.70
E	0.043	0.051	1.10	1.30
e	0.020 BSC		0.50 BSC	
L	0.004	0.012	0.10	0.30
C	0.003	0.006	0.08	0.16

UMD5V-553 Carrier Dimension



Mounting Pattern



Typical		
Dim	MM	Inches
C	1.40	0.055
G	0.51	0.020
P	0.30	0.012
X	1.02	0.040
Y	0.51	0.020

Dimensions in mm.

Reel Dia.	Tape Width	A0	B0	K0	ΦD0	E1
178mm (7")	8mm	1.78±0.05	1.78±0.05	0.69±0.05	1.50±0.10	1.75±0.10
F	W	P0	P1	P2	T	
3.50±0.05	8.00±0.30	4.00±0.10	2.00±0.05	4.00±0.10	0.20±0.05	



**SOT-553 Four Lines TVS Array for ESD Protection**

**Marking Code**

Part Number	Device Marking
UMD5V-553	553

**Ordering Information**

Part Number	Lead Finish	Qty Per Reel	Reel Size
UMD5V-553	Pb-Free	3,000	7 inch

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